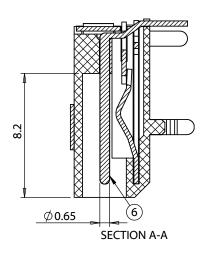
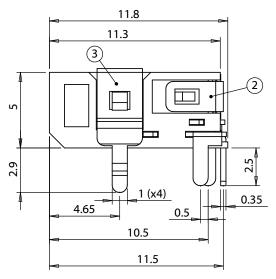


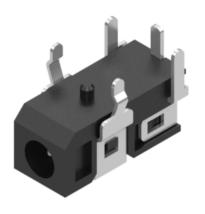
6

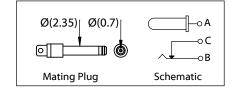
0.3 (x2)

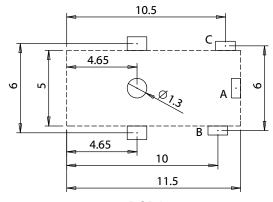
0.26 (x2)











Revision:	Date:	Description:	Prepared: Digitally signed by JP Date: 2018.09.27	Notes:					
Α	9/26/2018	Initial release	JP Date: 2018.09.27	Function test: no open, no short circuit, no intermittent		TENSILITY  tel 1.541.323.3228 800 877.670.7118 fax 1.541.323.4202 web tensility.com			
			Verified: AW Digitally signed by AW Oate: 2018.09.27 16:04:04						
			Dimensions are in millimeters. Tolerances:	Description:  Connector, dc jack 2.35x0.7 mm, PCB mount, 90°,			e: Part number: 54-00139		
			< 1.0: ± 0.1 mm 1.0 to 10.0: ± 0.2 mm > 10.0: ± 0.3 mm	lation of acad because to all		A Scale:			Sheet 1 of 2
·		5	4	3	2	·			1

## **Ratings**

Maximum operating voltage: 48 V

Maximum operating current: 5.0 A (not mated under load)

### **Operating Temperature Range**

-25 to 85 °C, relative humidity of 85% or less

#### Materials

1)Insulator: PBT, black

(2)Cover: brass, nickel plated

(3)Terminal: brass, tin plated

(4)Terminal: brass, silver plated

(5)Terminal: beryllium copper, silver plated

(6)Center Pin: brass, silver plated

# **Electrical Requirements**

Dielectric strength: 1 min @ 500 Vac

Insulation resistance: 100 M $\Omega$  @ 500 Vdc minimum

Contact resistance:  $50 \text{ m}\Omega$  maximum

#### **Mechanical Requirements**

Insertion force: 0.4-0.9 kgf

Withdrawal force: 0.3-0.7 kgf

Life cycle: 5000 mating cycles while maintaining contact resistance:  $100~\text{m}\Omega$  maximum, withstand voltage: 250~Vac, 1 min

Terminal strength: 300 gf applied to the terminal for 15 seconds in any direction while maintaining electrical characteristics and without damage or excessive looseness of terminals

# Soldering

Solderability: 75% minimum coverage when terminals dipped 2mm in 245  $\pm$ 5 °C solder bath for 3  $\pm$ 0.5 seconds

Solder bath durability: no deformation when immersed in 255  $\pm$ 5 °C up to surface of the board 1.6 mm for 5 seconds or less

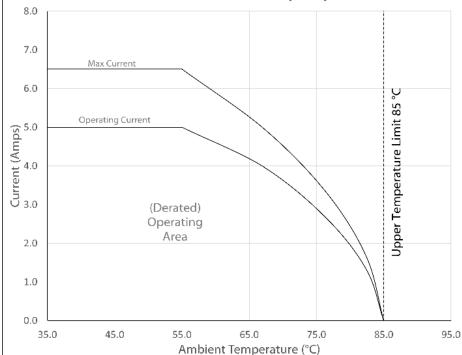
Solder iron durability: no deformation when exposed to 350  $\pm$ 10  $^{\circ}$ C for 3  $\pm$ 0.5 seconds

# **Environmental Requirements**

Cold test:  $-25 \pm 3$  °C for 48 hours without deformation Heat test:  $85 \pm 2$  °C, relative humidity 45-85% for 48 hours without deformation

Humidity test:  $40 \pm 2$  °C, relative humidity 90-95% for 48 hours without deformation

Connector Current Capacity



Testing based on IEC 60512-5-2. Max current curve generated with isolated test article under controlled environmental conditions, and does not take into account external factors such as housings, mating cables, or other circuitry. Operating current curve (derated by 20% of maximum values) accounts for external factors, and manufacturing variation.

# **Wave Soldering Temperature Profile**

Pb - Free Flow Profile

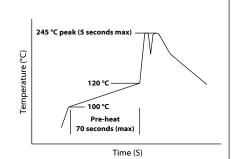
Solder temperature: 245 °C

Time: 5 seconds maximum

Pre-heat: 100 ~120°C

Time: 70 seconds maximum

Measure point: surface of the solder leads



Revision:	Date:	Description:	Prepared:	Notes: Function test: no open, no short circuit, no intermittent					
Α	9/26/2018	Initial release	JP Digitally signed by JP Date: 2018.09.27 15:59:52-07:00'				FNSII ITY		
			Verified: AW  Digitally signed by AW Date: 2018.09.27 16:04:17 -07'00'			tel 1.541.323.3228 800 877.670.7118			
			Dimensions are in			fax 1.541.323.4202 web tensility.com			
			millimeters.	mm Connector, dc jack 2.35x0.7 mm, PCB mount, 90°, silver plated, board lock		Size:	Part number:		
			Tolerances: < 1.0: ± 0.1 mm			Α	54-00139		
			1.0 to 10.0: ± 0.2 mm > 10.0: ± 0.3 mm			Scale:	: 5:1 Sheet 2 of 2		

3 2